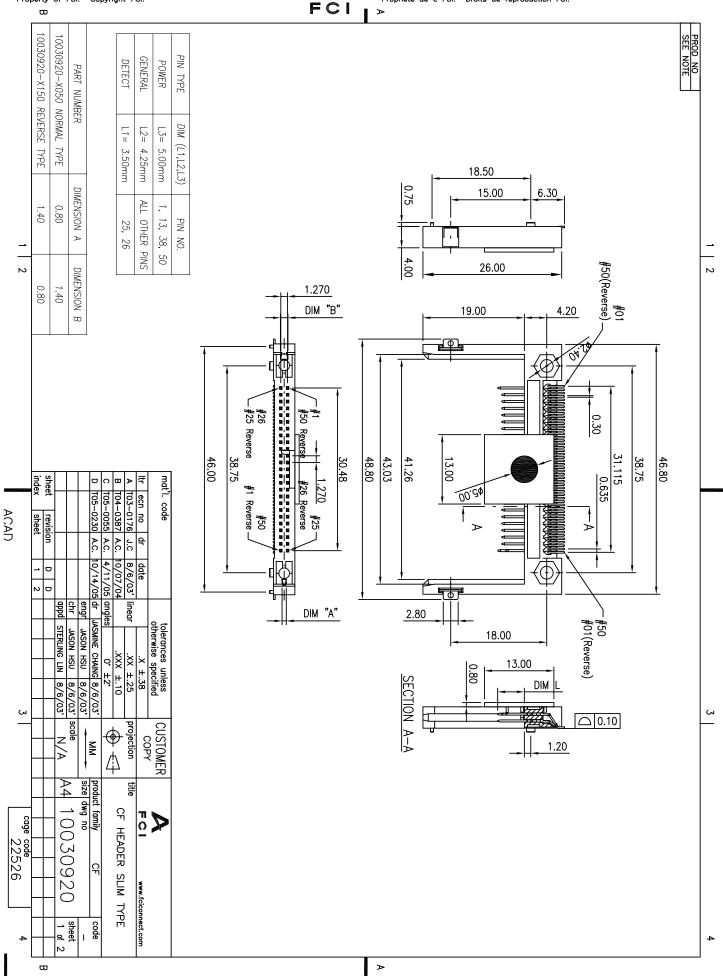
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FCI

12 Specification:

Solderable Holddown: Copper Alloy

Contact: Copper Alloy.

Housing: High Temperature Thermoplastic, UL94V-0.

2

NOTES:

Materials:

Packaging Spec: GS-14-933 Product Spec: GS-12-240. Tin/Lead Plating Spec:

lemperature For 10 Seconds In A Convection, IR Or Vaper

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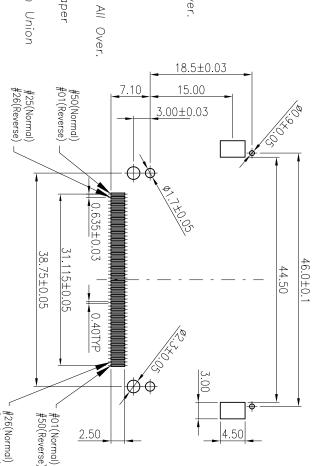
Directive as Described in GS-22-008. This Product (10030920-XXXXXLF) Meets the European Union Phase Reflow Oven.

9

7. Part Number Description.

P/N: 10030920-XX50XLF

4. Lead—Free Plating Spec: Contact: Under Plated 50u" Min. Nickel All Over, 100u" Min. Pure Matte Tin in Solder Tail Area, Selective Gold Plating in Contact Area. Contact: Under Plated 50u" Min. Nickel All Over, 100u" Min. Tin/Lead in Solder Tail Area Selective Gold Plating in Contact Area. Solderable Holddown: Under Plated 50u" Min. Nickel, Solderable Holddown: Under Plated 50u" Min. Nickel, The Housing Will Withstand Exposure to 260°C Peak Plated 100u" Min. Pure Matte Tin Plated 100u" Min. Tin/Lead All Over. Lead in Solder Tail Area,



sheet mat'l. code ecn no ACAD revision 4 date engr chr appd dr JASMINE CHAING 8/6/03 tolerances unless otherwise specified
.x ±.38 STERLING LIN JASON HSU JASON HSU .XXX ±.10 .XX ±.25 0° ±2° 8/6/03' scale projection CUSTOMER ф Д COPY ₹ product family size dwg no A 4 title 10030920 CF HEADER SLIM TYPE П О cage code 22526 fciconnect.com sheet 2 of code

— GOLD PLATING: A: GOLD FLASH D: 15u" GOLD PLATE E: 30u" GOLD PLATE

2

KEY TYPE: 0: NORMAL TYPE 1: REVERSE TYPE

PIN COUNT.

BLANK: WITHOUT PICK-UP CAP. P: WITH PICK-UP CAP

LEAD—FREE PLATING OPTION:
BLANK: TIN/LEAD PLATING SPEC(SEE NOTE3). LF: LEAD-FREE PLATING SPEC(SEE NOTE4)

RECOMMENDED P.C.B LAYOUT

GENERAL TOLERANCE ±0.05

#25(Reverse)

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Printed: Oct 14, 2008

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STATUS: Released

PDM: Rev:D